

45 4580 01 MP T0,8

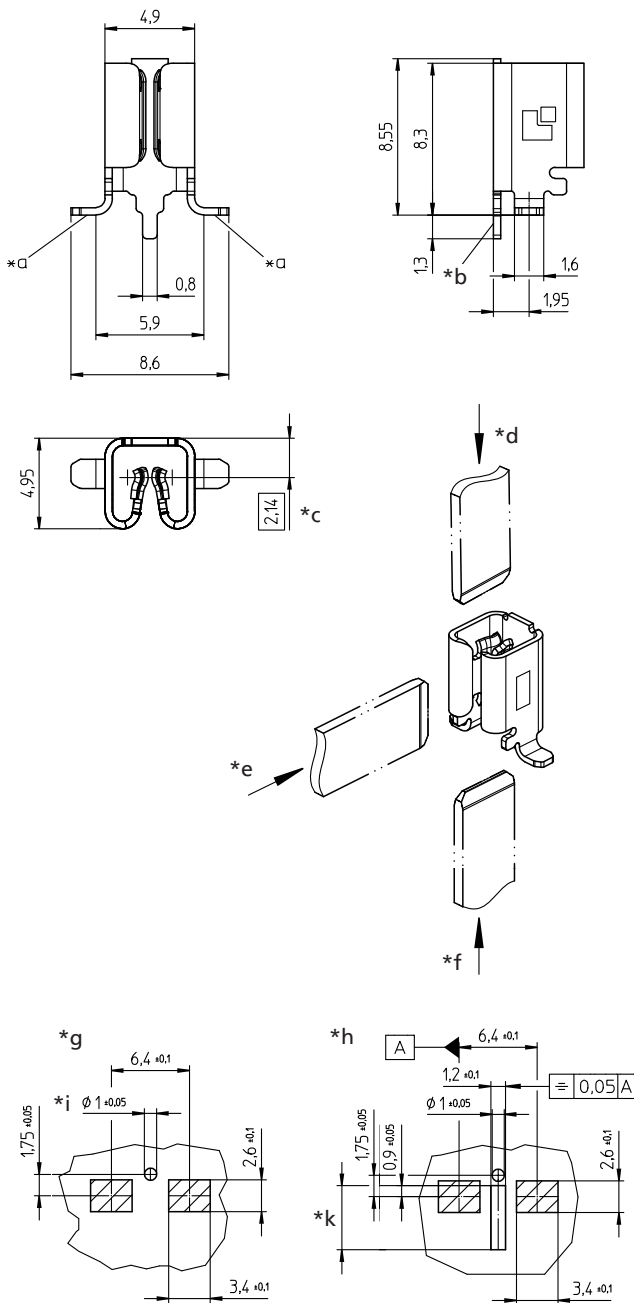
High-current contact elements



High-current contact bush with positioning peg, in surface mount technology (SMT), mateable from top, bottom or lateral direction, for tab contacts 0.8 mm, for printed circuit boards or busbars

Approvals: **LV215**

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Environmental conditions

Temperature range -40 °C/+120 °C

Materials

Contact CuCr alloy, tin-plated

Mechanical data

Mating with tab contact 2.8–6.8 mm x 0.8 mm applicable for reflow soldering on printed circuit board applicable for laser welding on a busbar or lead frame

Mating cycles ≤ 5
Insertion force 32 N ± 15 N – top entry
18 N ± 10 N – lateral entry
32 N ± 15 N – bottom entry¹

Withdrawal force 32 N ± 10 N – top entry
15 N ± 10 N – lateral entry
32 N ± 10 N – bottom entry¹

¹ measured with a tin-plated test tab

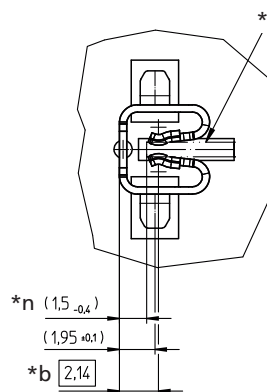
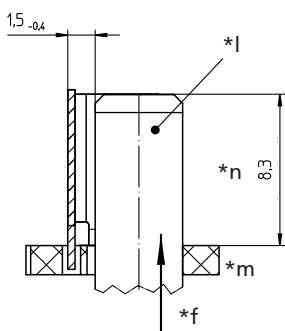
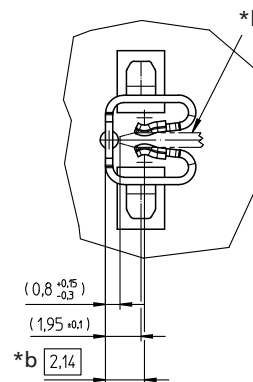
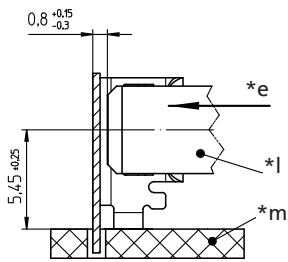
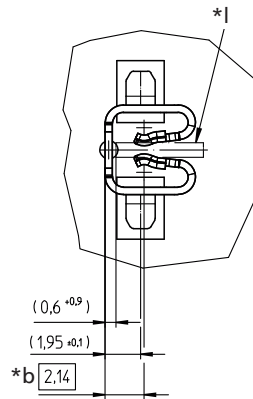
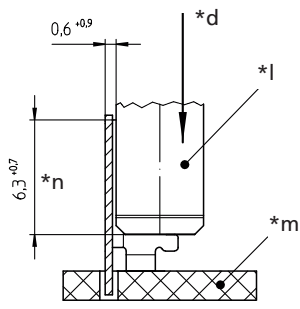
Electrical data (at T_{amb} 20 °C)

Contact resistance < 1 mΩ

Rated current ≤ 56 A¹

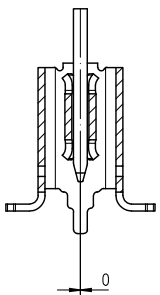
¹ depending on the connection to the printed circuit board/busbar, installation situation and heat dissipation

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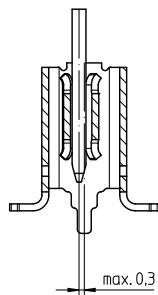


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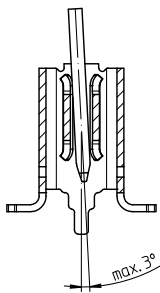
Assembly tolerances for top and bottom entry
 - tab dimensions 4.8 mm x 0.8 mm x length 8 mm
 - larger assembly tolerances possible for lengths > 15 mm



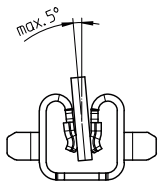
typical mating



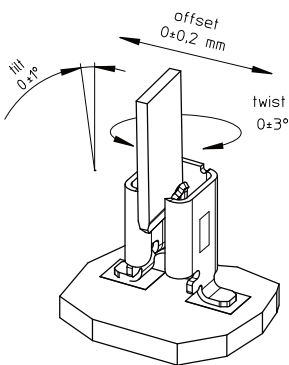
permissible lateral offset



permissible tilt



permissible twist



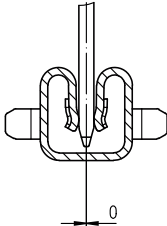
permissible combined tolerances

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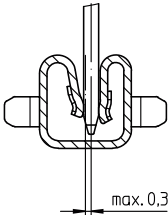
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Assembly tolerances for lateral entry

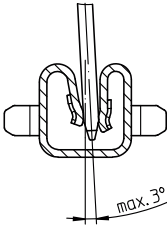
- tab dimensions 4.8 mm x 0.8 mm x length 8 mm
- larger assembly tolerances possible for lengths > 15 mm



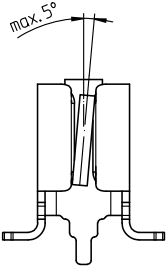
typical mating



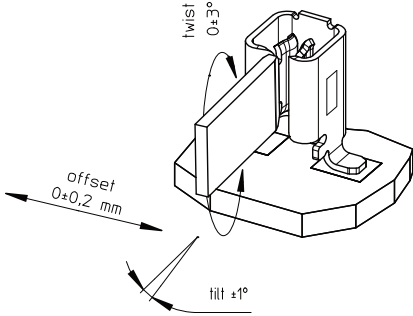
permissible lateral offset



permissible tilt



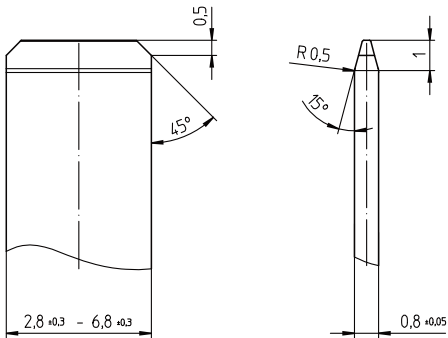
permissible twist



permissible combined tolerances

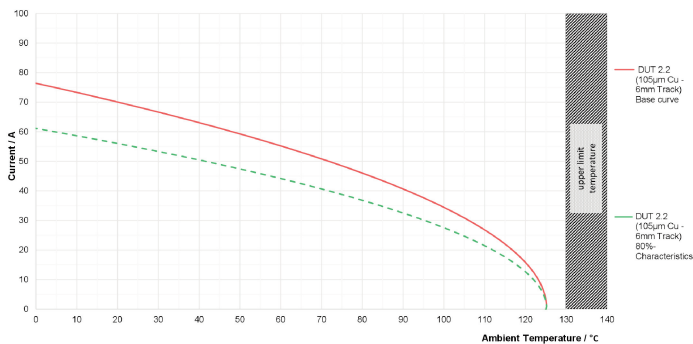
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Geometry of the mating tab contact



Material to be coordinated with Lumberg.

Derating diagram



Test setup: application example of a closed system, no air circulation, no heat dissipation

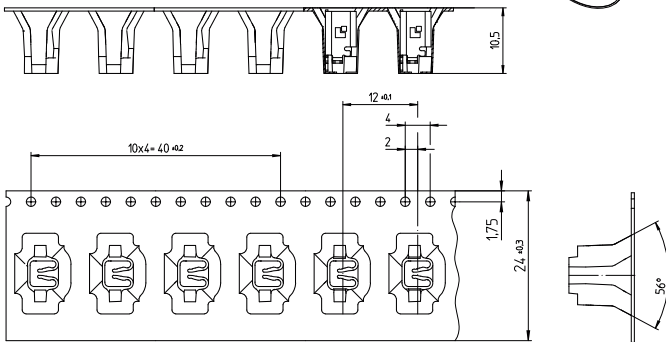
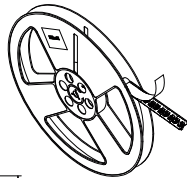
- tab contact: CuZn37, tin-plated, 4.8 mm x 0.8 mm (corresponding to a cross section of 4 mm²)
- connected wire: section 6 mm²
- PCB: double-sided, conductor thickness 105 µm, track width 6 mm
- ambient temperature: 20 °C

Further test configurations and details upon request.

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Packaging

reel: 330 mm/110 mm/24,5 mm
leader: 408 mm, 34 empty cavities
trailer: 168 mm, 14 empty cavities



- *a SMT solder area
- *b positioning peg
- *c contact point
- *d mating from top direction
- *e mating from lateral direction
- *f mating from bottom direction
- *g printed circuit board layout (example) for mating from top or lateral direction
- *h printed circuit board layout (example) for mating from bottom direction
- *i bore hole for positioning peg
- *k slot in the printed circuit board min. 0.5 mm wider than tab
- *l contact tab
- *m printed circuit board
- *n insertion depth

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Designation	Pole Number	PU (Pieces)	MDQ (Pieces)
4580 01 MP T0,8 V12VP12	1	500	

Packaging:

on reel

4580 01 - High-current contact

Overview acc. LV 215 Edition (VW 80332: 2021-02)

Test PCB: FR4 1.6 mm ±10 % (IPC 4101C/121) TG (DSC= 170 °C / 2 layers Cu 105 µm / 6 mm)

Connection wire cross section for high load: 6 mm²



Version: 1

13.06.2025

Test group		Results	
TG 1	Dimensions	OK	
TG 2	Material and surface analysis, contacts	OK	
TG 3	Material and surface analysis, housing	OK*	
TG 4	Contact engagement Length	Contact overlap – Plug in direction top/bottom	OK
		Contact overlap – Plug in direction horizontal	with limitations Design-related contact overlap 0.69 mm
TG 5	Mechanical and thermal relaxation behaviour	OK	
TG 6	Interaction between contact and contact housing	OK*	
TG 7	Handling and functional reliability of the contact housings	OK*	
TG 8	Insertion and holding forces of the contact parts in the contact housing	OK*	
TG 9	Pin insertion angle/misuse-proofing (scoop- proofing)	OK	
TG 10	Contacts: Based on PG 10 - Misuse / Share force from PCBA SMD variant only	OK	
TG 11	Contacts: Insertion and extraction forces; number of mating cycles	Insertion/extraction direction from horizontal/front side	OK
		Insertion/extraction direction from top side/bottom side	with limitations Change in insertion force up to 30 %
		Insertion force change max. 25 % on each sample between 1st and 5th insertion	
TG 12	Current heating derating - free in air	OK	
TG 13	Derating wit housing	OK	
TG 14	Thermal time constant	OK	
TG 15	Electrical stress test	OK	
TG 16	Fretting corrosion	OK	
TG 17	Dynamic loading - Severity 2	OK	
TG 18 A	Coastal climate stress	OK*	
TG 19	Environmental simulation	OK	
TG 20A	Environmental load of the housing	OK*	
TG 21	Long-term temperature aging	OK*	
TG 22A	Chemical resistance	OK*	

*= not relevant for the application